

# Latest results from development of $n^+$ -in-p planar pixel sensors and LGAD devices by KEK/HPK

Y. Unno (KEK)

for ATLAS-Japan Silicon Collaboration  
& Hamamatsu Photonics K.K.

# Contents

- Two talks combined...
- Latest results from development of n<sup>+</sup>-in-p planar pixel sensors
  - 50×50 and 25×100 μm<sup>2</sup> pixels with FE-I4 readout ASIC
  - Non-irradiated, and irradiated with protons
  - Efficiency mapping of various pixel structures
- Latest results from development of LGAD devices
  - Diodes (and strips)
  - Non-irradiated, and
  - Irradiated with gammas or neutrons

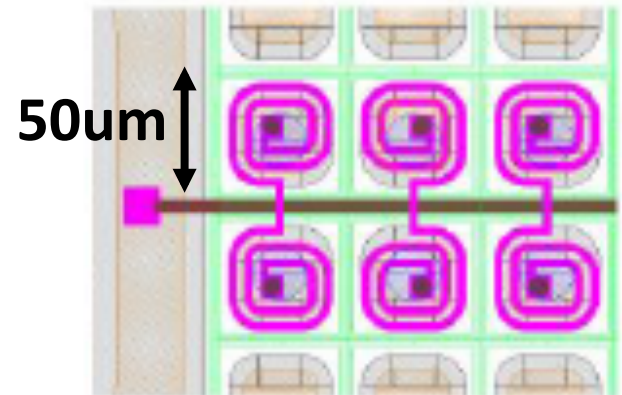
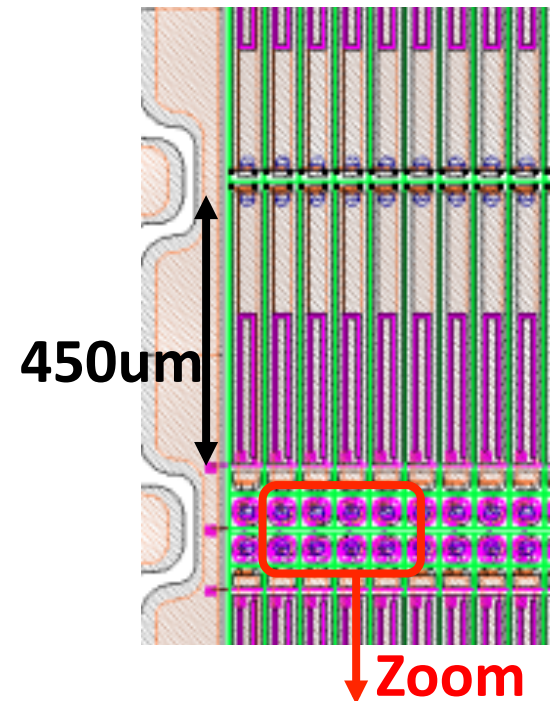
# 50×50 and 25×100 $\mu\text{m}^2$ pixels with FE-I4 readout ASIC

Main contributor:  
Kazuyuki Sato (Uni. Tsukuba)

# Motivation

- To design planar pixel sensors with  $50 \times 50 \mu\text{m}^2$  pixels
  - The pixel size for HL-LHC upgrade
  - ASIC being developed by RD53
- To test the pixel structures with working readout ASIC, FE-I4
  - $2 \times (50 \times 250) \rightarrow$
  - $50 \times 50 / 25 \times 100 + 50 \times 450 \mu\text{m}^2$
- Evaluation with beams from CERN SPS
  - 120 GeV pions
  - 2016 Aug Testbeam
  - 2016 Nov Testbeam

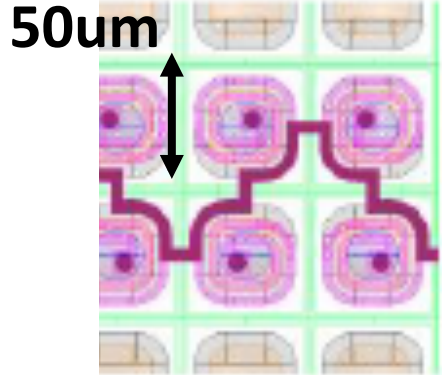
## Ex Type1



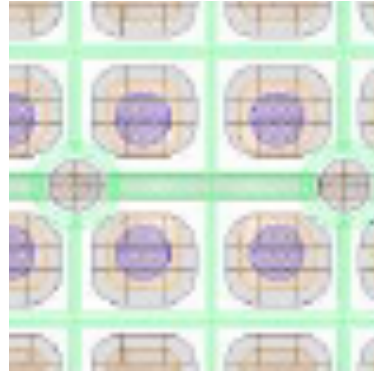
# Pixel Structures

Non Irrad

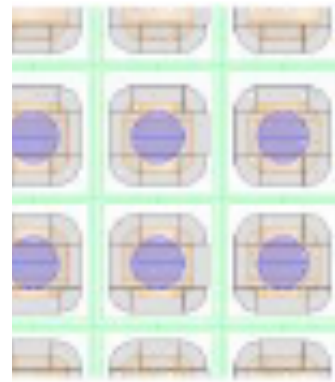
Type2 Small Offset



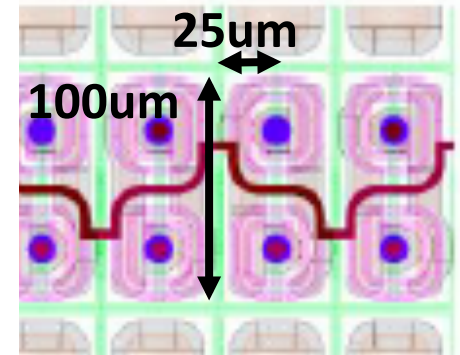
Type3 PT



Type5 No Bias

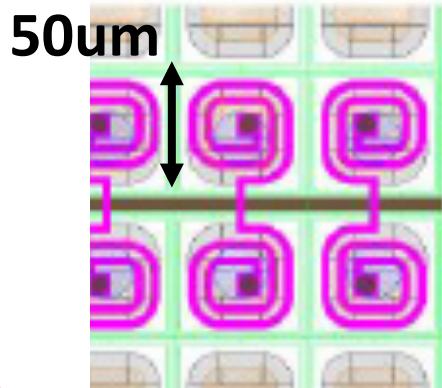


Type6 25um x100um Small Offset

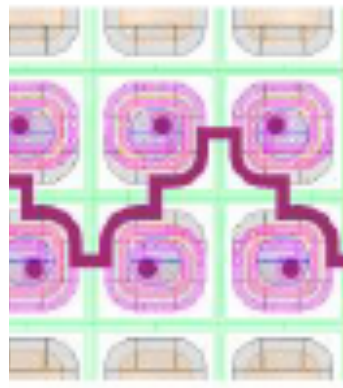


Proton Irrad  $3 \times 10^{15}$  1MeV  $n_{eq}/cm^2$

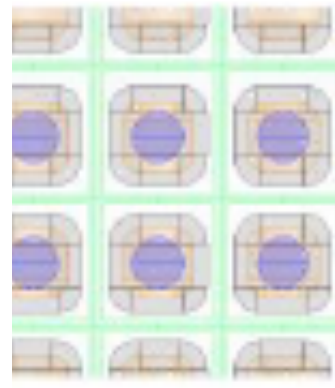
Type1 No Offset



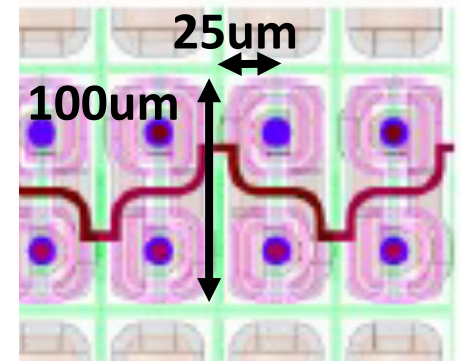
Type2 Small Offset



Type5 No Bias



Type6 25um x100um Small Offset



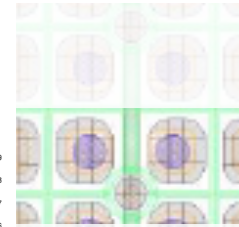
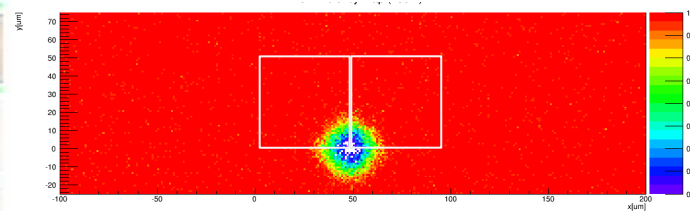
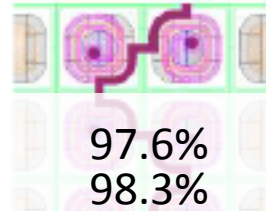
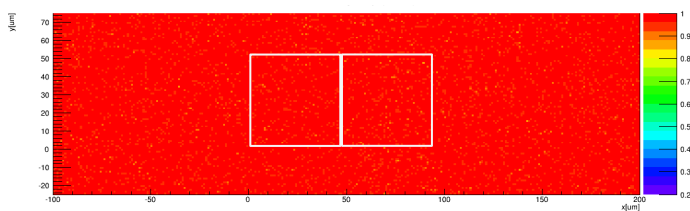
# Efficiency Map in Pixel – Non irradi.

- Little efficiency loss in non-irrad. devices with PolySi bias network.
- Efficiency loss observed with the PT structure.
  - PT dot ( $n^+$ ) is “visible” to the drifting charges. Then,
  - charges are induced to the PT dot and lost (from the readout pixels).

**Type2 (PolySi) 200V**

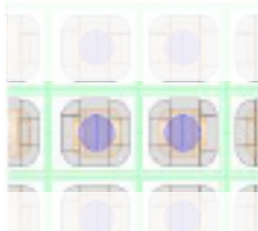
Eff.:  
Overall  
Central

**Type3 (PT dot) 200V**

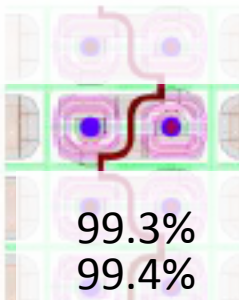
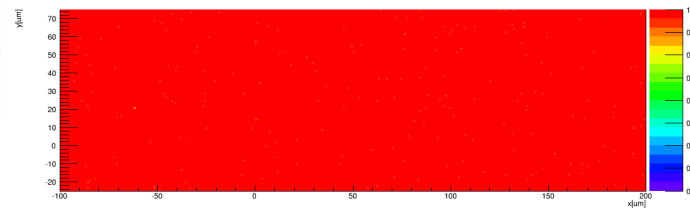
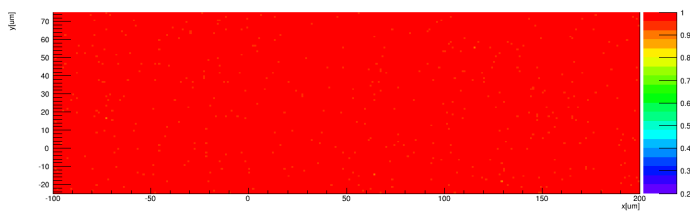


Systematics → (98.5% 50×450  $\mu\text{m}^2$ )

**Type5 (No bias) 200V**



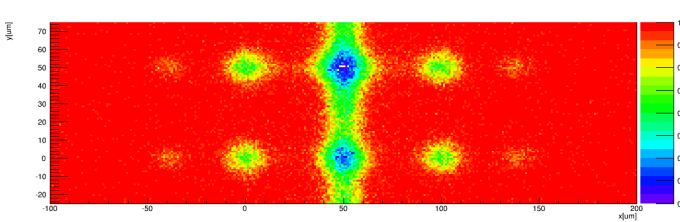
**Type6 (25×100, PolySi) 200V**



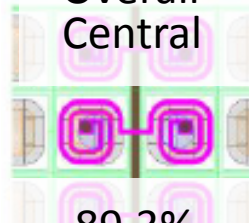
# Efficiency Map in Pixel – Irrad.

- Proton Irrad.  $3 \times 10^{15}$  1MeV  $n_{eq}/cm^2$
- Efficiency loss under the bias rail (in Type1 (wide p-stop))
- Efficiency loss at the four corner of four pixels due to charge sharing and high threshold (3000 e) (e.g. in Type5 (No bias))
  - was improved with lowered threshold
  - In future, 500 e (?) with the new RD53 ASIC.
- In Type6, efficiency loss at the four and the three corners of  $2 \times 25 - 50 \mu m$

**Type1(No offset) 1000V**

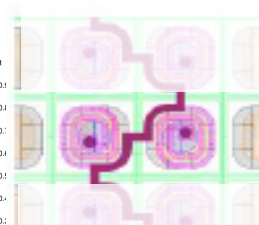
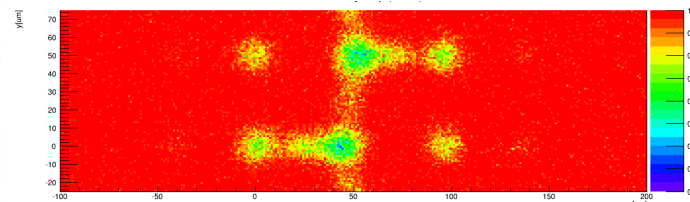


Eff.:  
Overall  
Central



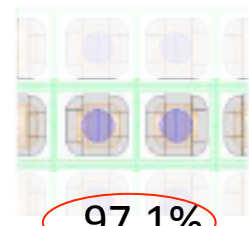
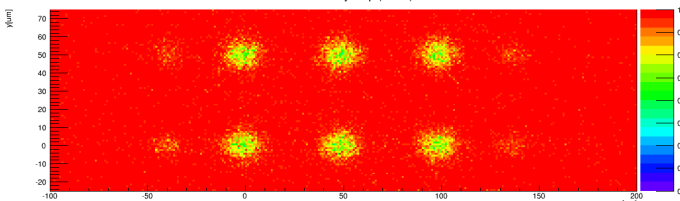
89.3%  
99.0%

**Type2(Large offset) 1000V**



93.9%  
99.2%

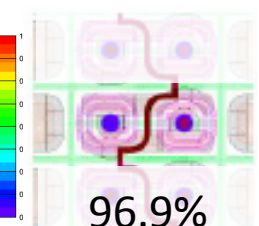
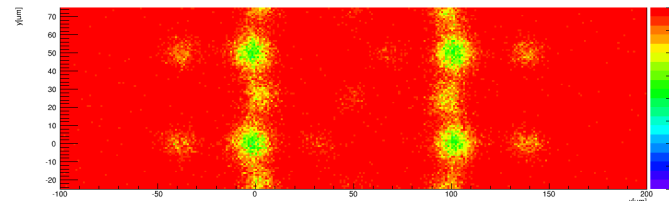
**Type5(No bias) 1000V**



97.1%  
99.3%

(to-be improved with  
lower threshold)

**Type6(25x100) 1000V**

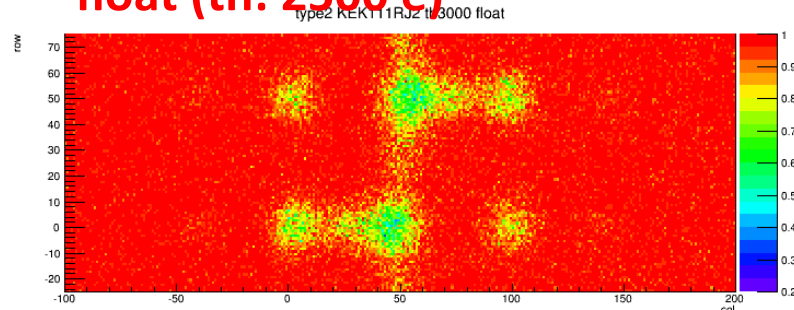


96.9%  
99.2%

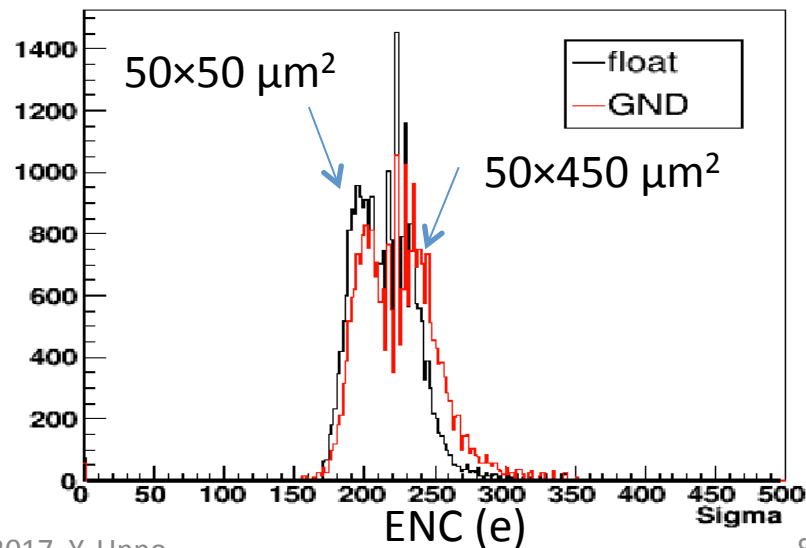
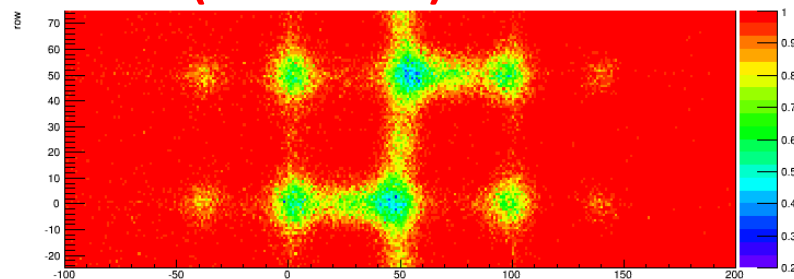
# Biasing network, floating or GNDing

- Bias rail connection:
  - Default: float
  - Trial: GND
- Efficiency loss:
  - In an irradiated device
  - GND > float
  - Charges are induced to the electrodes with a fixed potential.
    - The more fixed, the more induced charges (?)
- Noise (ENC):
  - Two peaks because of two pixel sizes ( $50 \times 50 \mu\text{m}^2$ ,  $50 \times 450 \mu\text{m}^2$ )
  - GND  $\geq$  float

float (th: 2500 e)



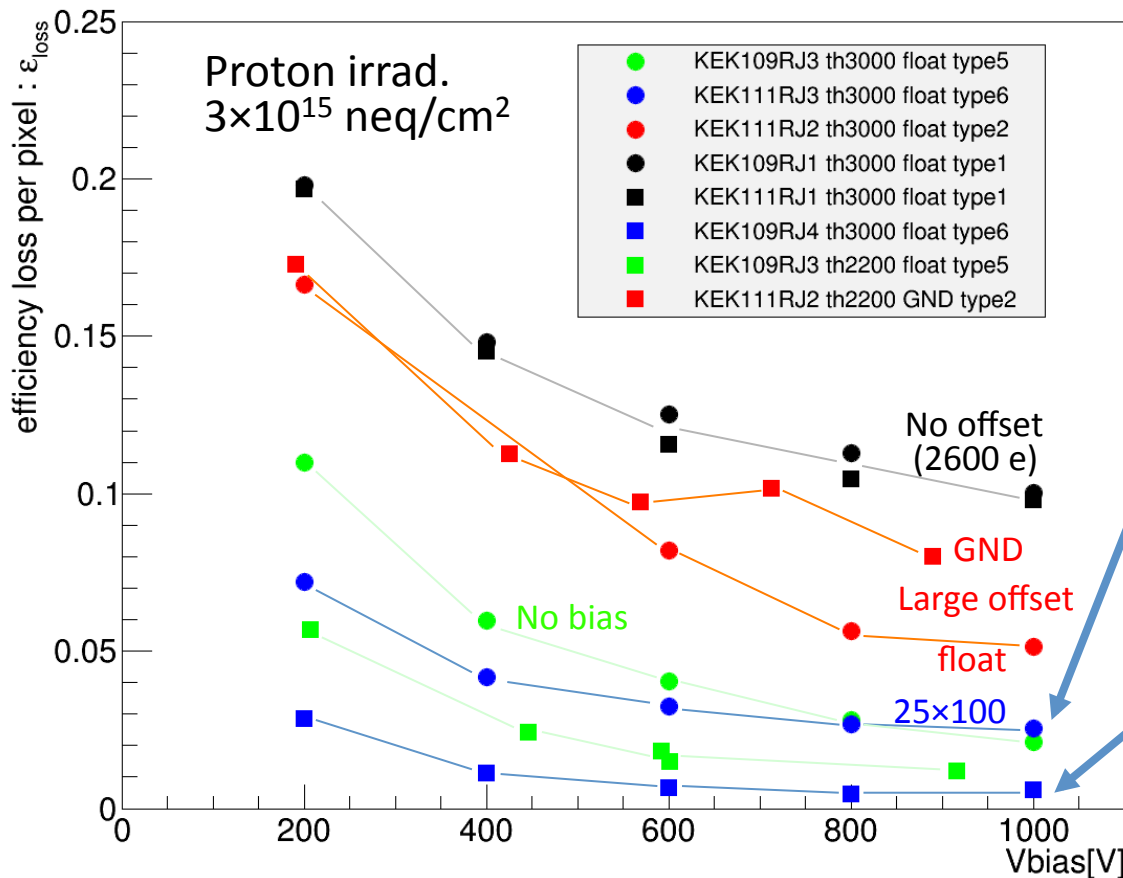
GND (th: 2300 e)



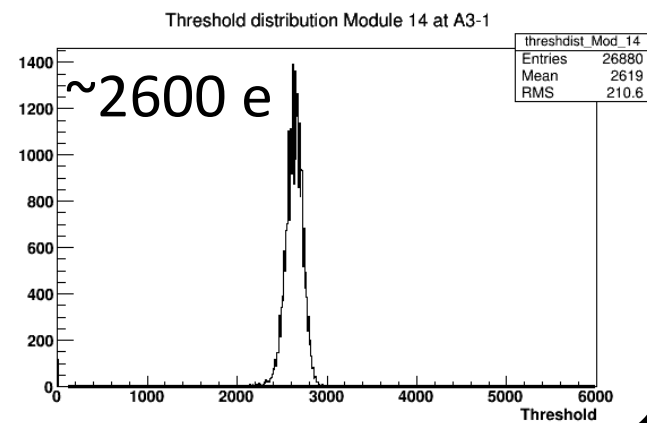
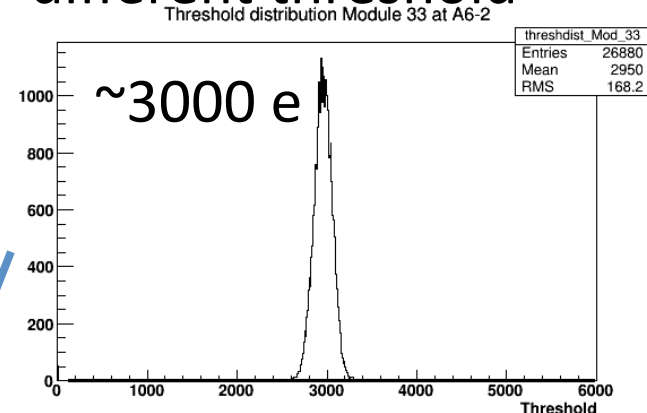


# Efficiency Loss per Pixel – Irrad.

- Type5 (no bias) < type2 (small offset) < type1 (no offset)
- Type5 threshold : 2600 e < 3000 e
- Bias rail connection: float < GND



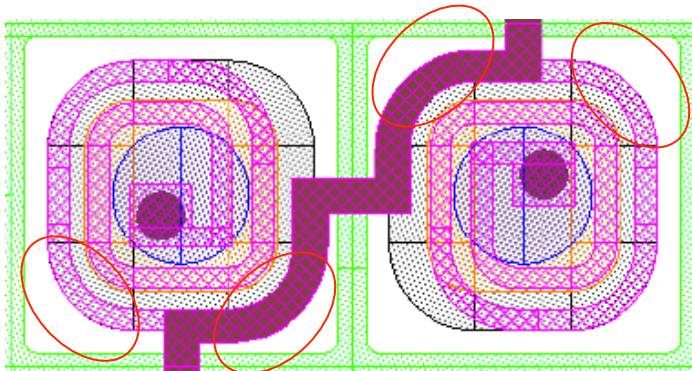
Different  $\epsilon_{\text{loss}}$  in the same structure ← different threshold



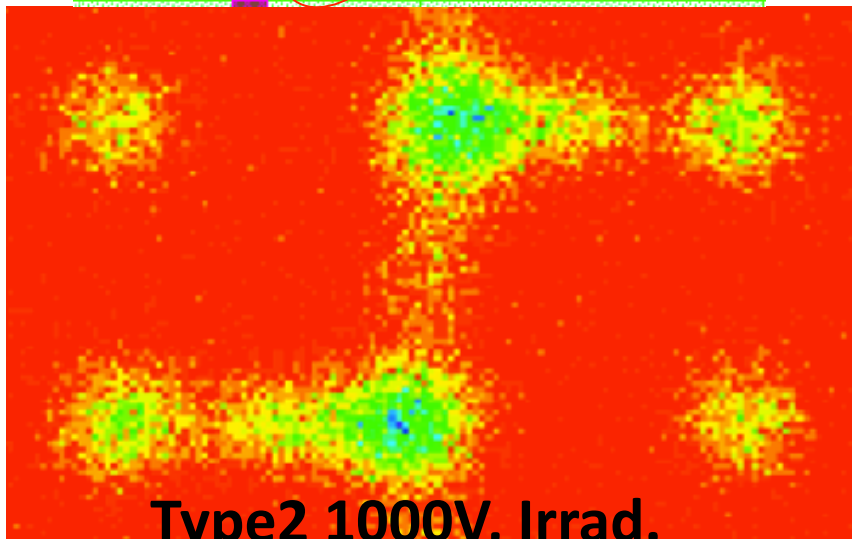
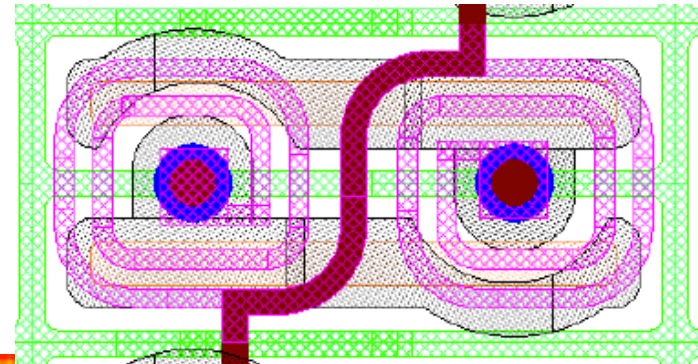
# Can Type 2 be Improved?

- Yes. We have now understood which structures have caused the efficiency loss...

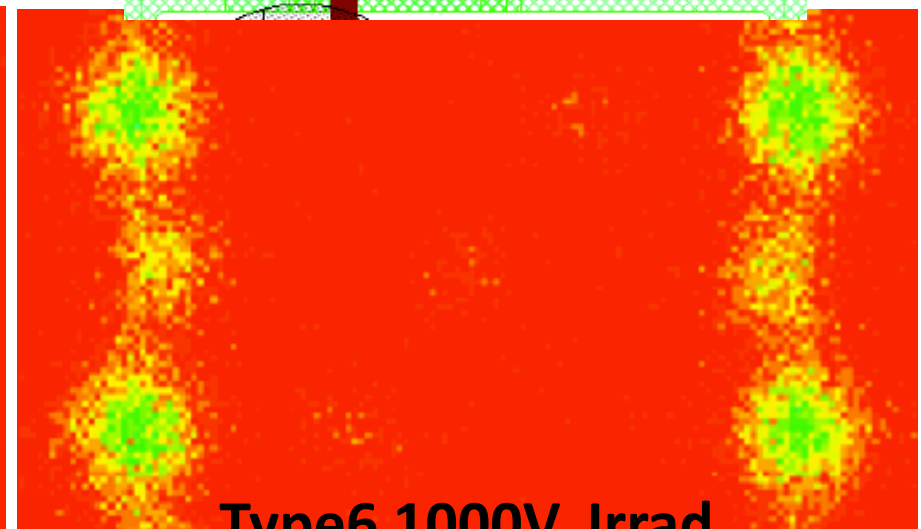
Type2:  $50 \times 50 \mu\text{m}^2$  pixel



Type6:  $25 \times 100 \mu\text{m}^2$  pixel



**Type2 1000V, Irrad.**

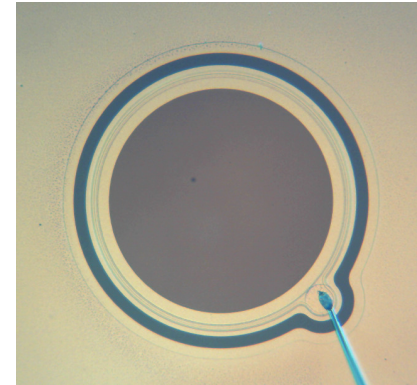
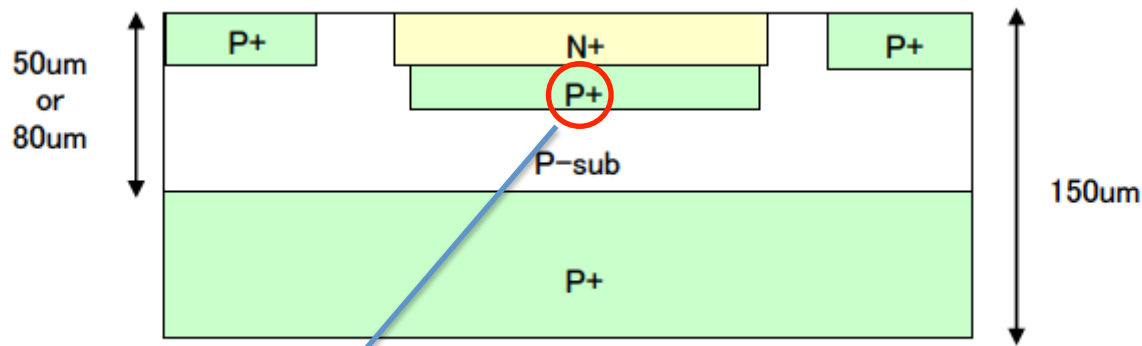


**Type6 1000V, Irrad.**

# LGAD Devices (Diode, Strip) before and after gamma/neutron irradiation

Main contributor:  
Sayaka Wada (Uni. Tsukuba)

# Diode Samples

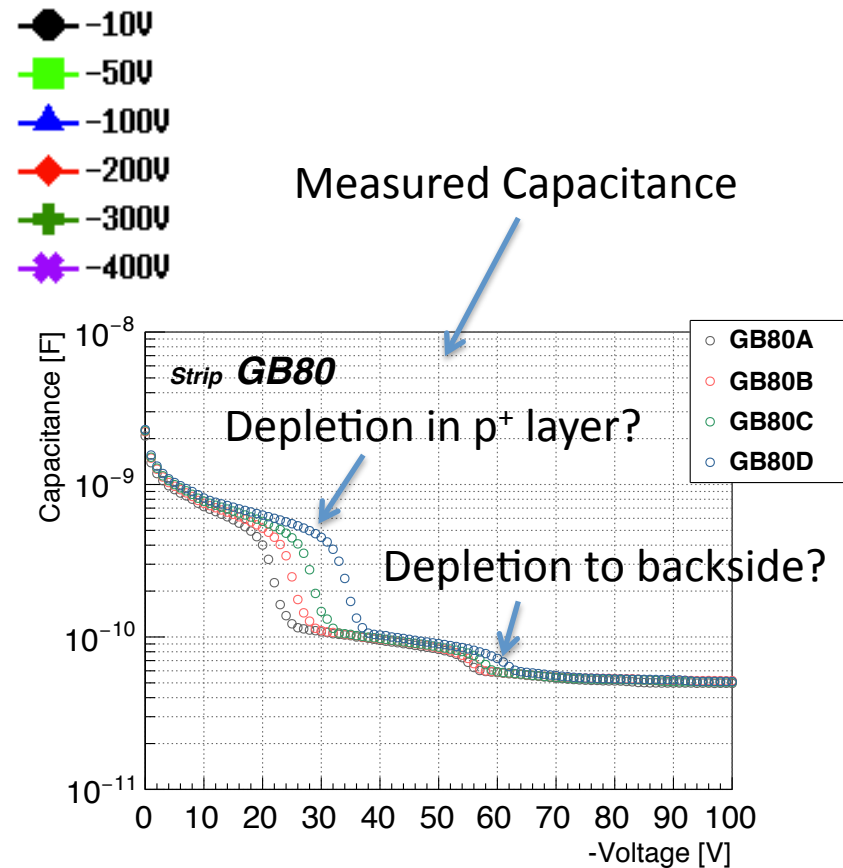
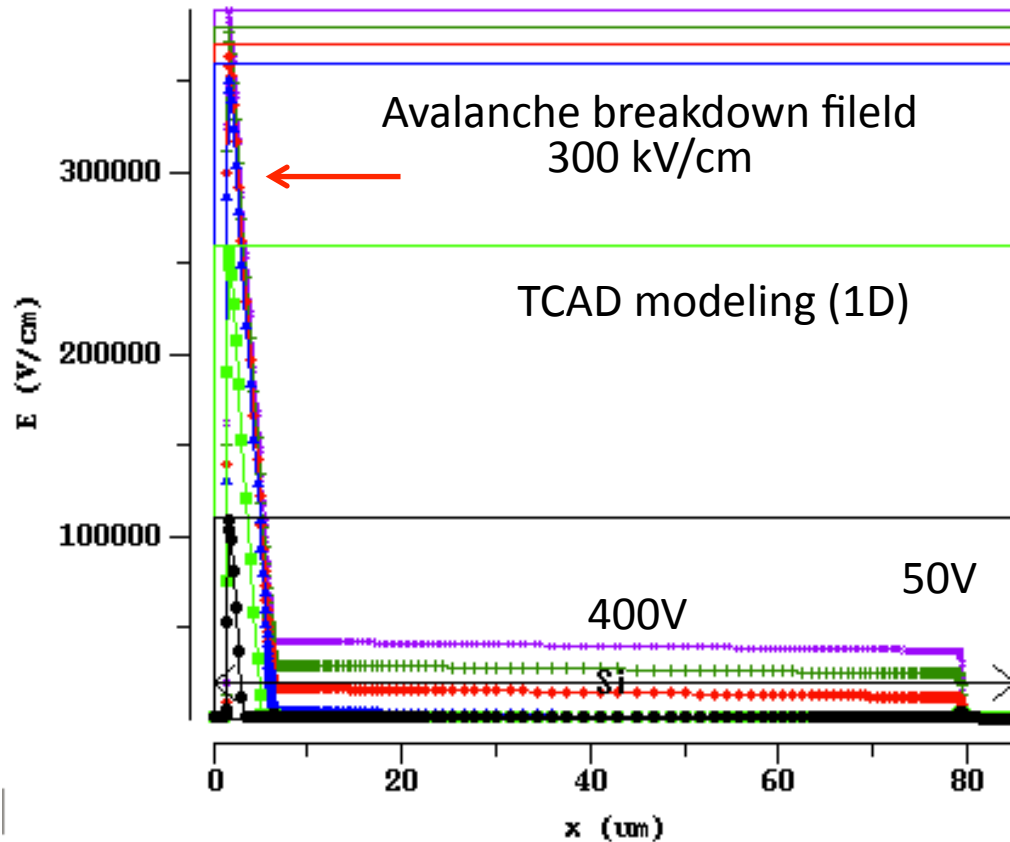


Sample Name	P <sup>+</sup> density	Physical Thickness [μm]	Active Thickness [μm]
50A	A low	150	50 (3~8kΩcm)
50B	B		
50C	C		
50D	D high		
80A	A	80	80 (1kΩcm)
80B	B		
80C	C		
80D	D		

- Diode
- Chip size:
  - 2.5 × 2.5 mm<sup>2</sup>
- Window: 1 mm  $\phi$

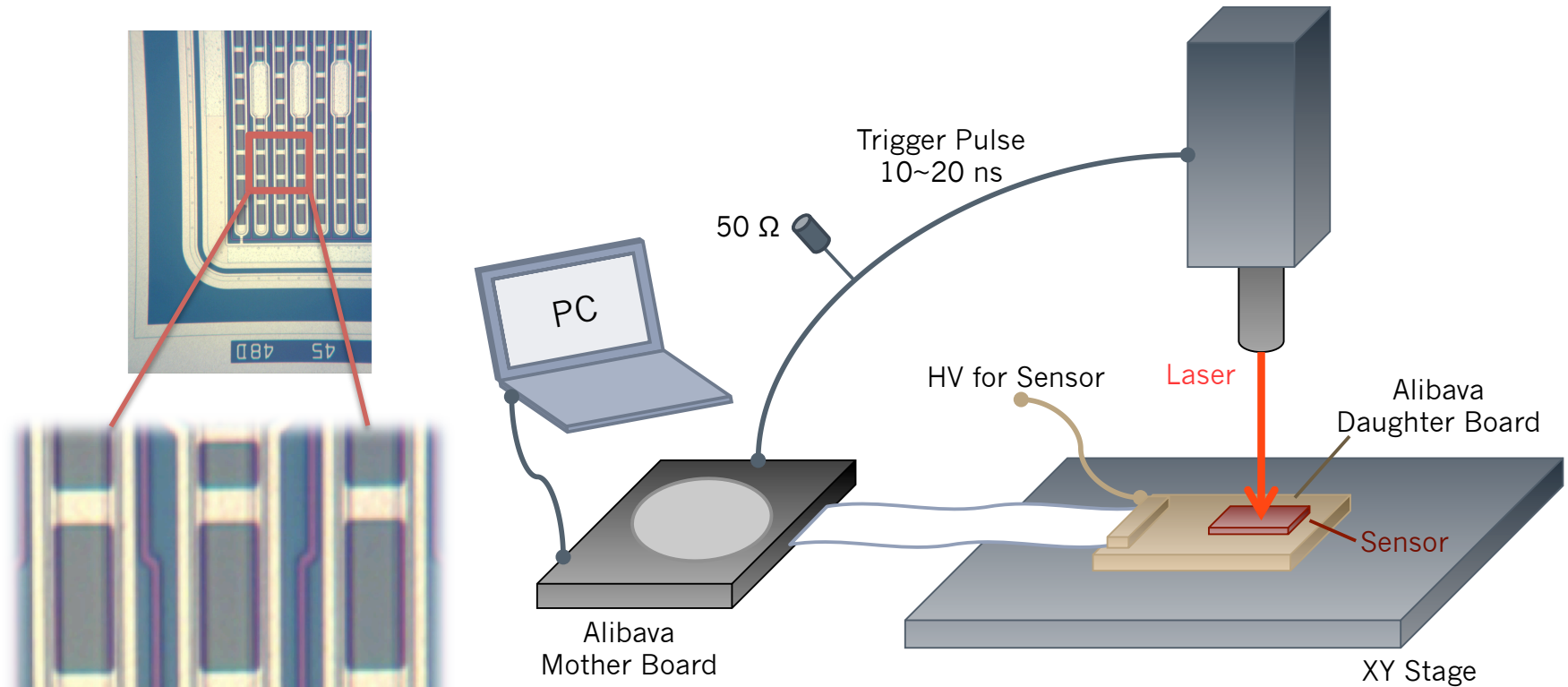
# Some Basics – Electric field

Non-irrad. p+ 5e15 psub 4.7e12

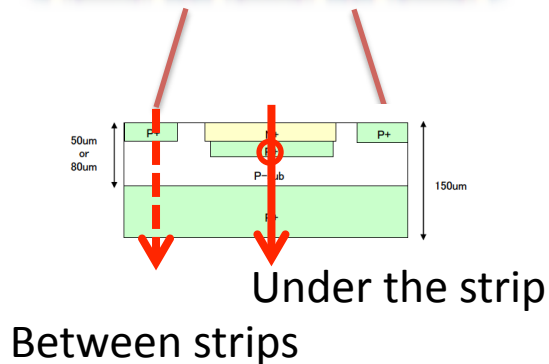


- Electric field calculations with a TCAD program
- Critical electric field for avalanche breakdown – 30 V/ $\mu\text{m}$

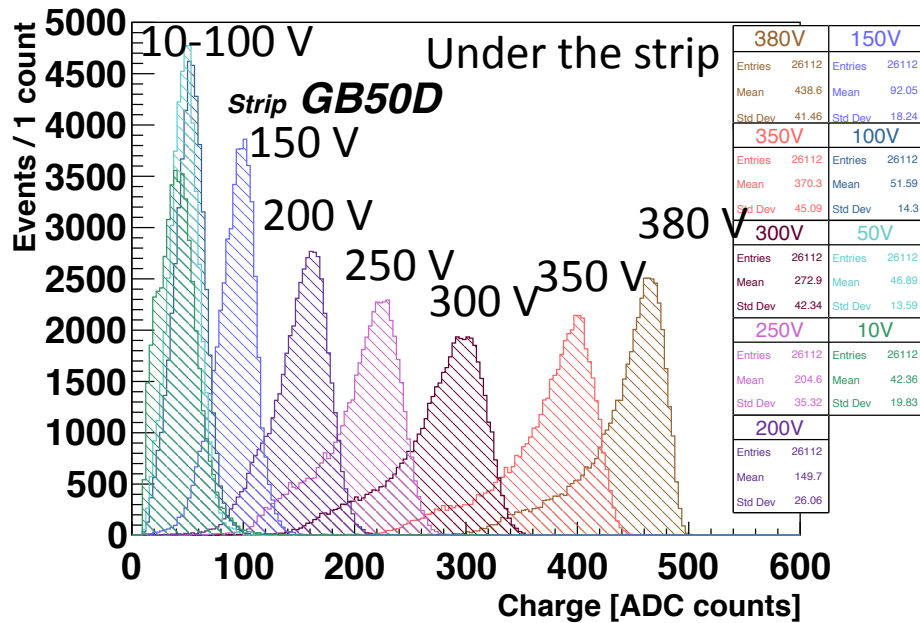
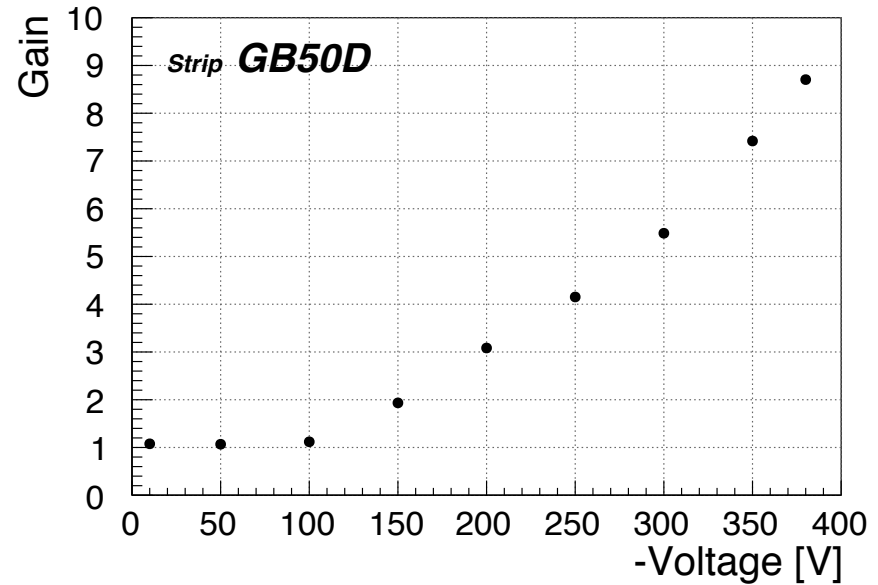
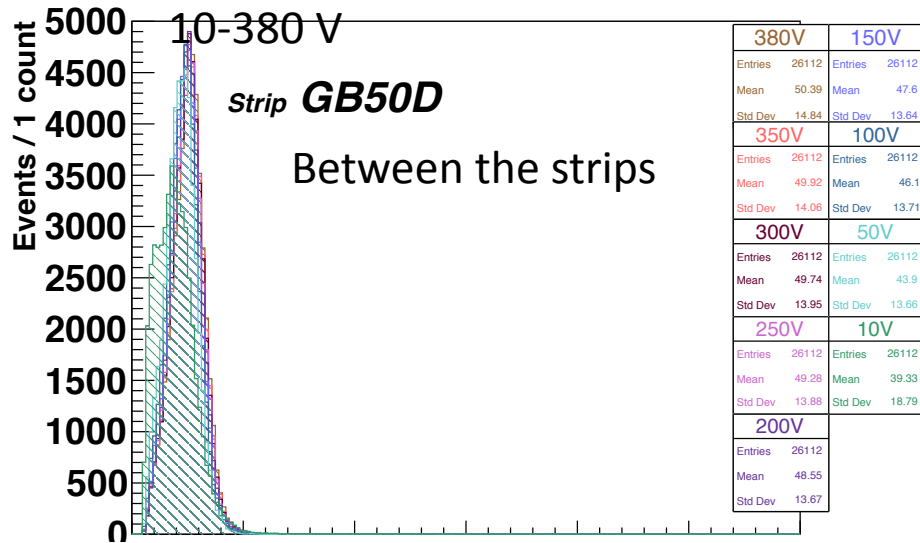
# Charge Amplification (Gain)-Strip Sample



- Strip:
  - chip size:  $6 \times 12 \text{ mm}^2$
  - strip pitch:  $80 \mu\text{m}$
- IR-Laser
  - $\lambda = 1064 \text{ nm}$ ,  $D \sim 1 \text{ mm}$
  - Penetrate fully



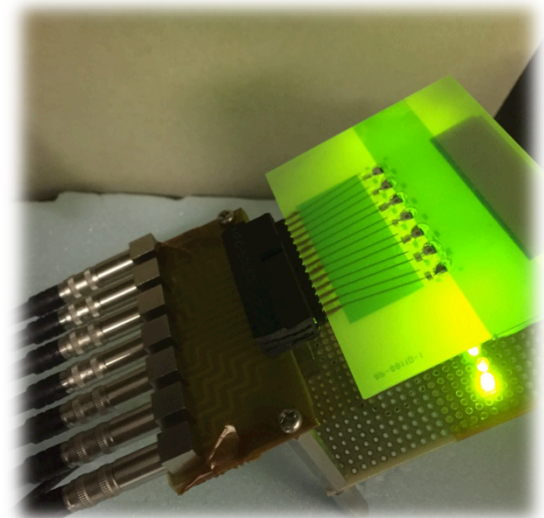
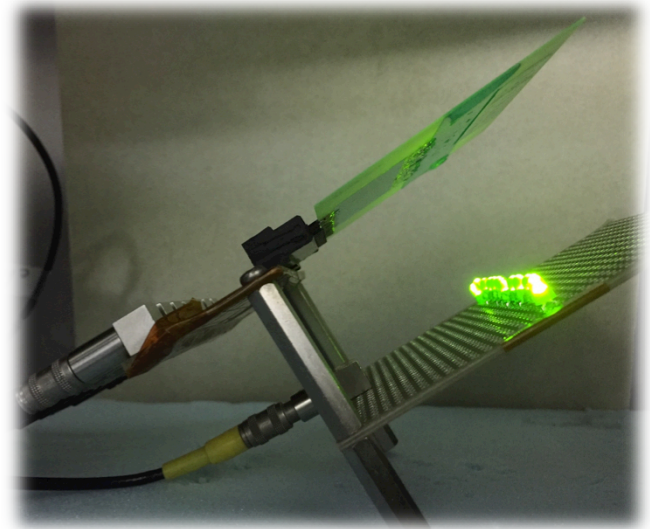
# Gain, Non-irrad. – Strip sample



- Gain is observed at  $\geq 100$  V

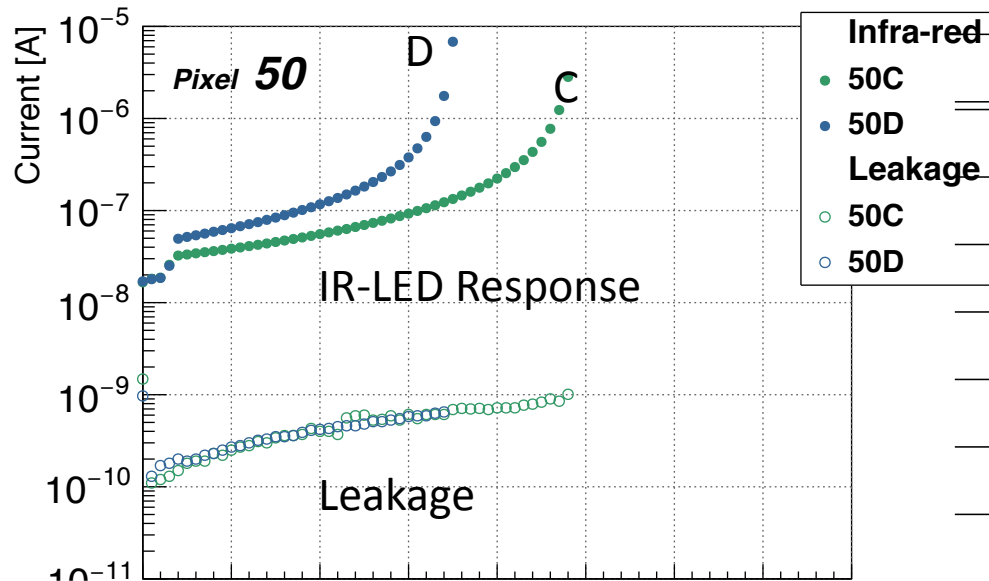
# Measurements – Diode samples

- Leakage currents
- Current generation by LEDs
  - Blue ( $\lambda=464\text{nm}$ ,  $D=0.5\mu\text{m}$ )
  - Green( $\lambda=565\text{nm}$ ,  $D=2\mu\text{m}$ )
  - Red ( $\lambda=627\text{nm}$ ,  $D=3\mu\text{m}$ )
  - Infra-red ( $\lambda=850\text{nm}$ ,  $D=20\mu\text{m}$ )
  - LED power control: Amplitude of 5 kHz square pulses (50% duty cycle)
- Dependence on
  - $p^+$  density
    - Values (confidential to HPK)
  - temperature
- Before and after irradiation
  - gamma (at Takasaki)
  - neutrons (at Ljubljana)
  - Annealing: 60 °C – 80 min.

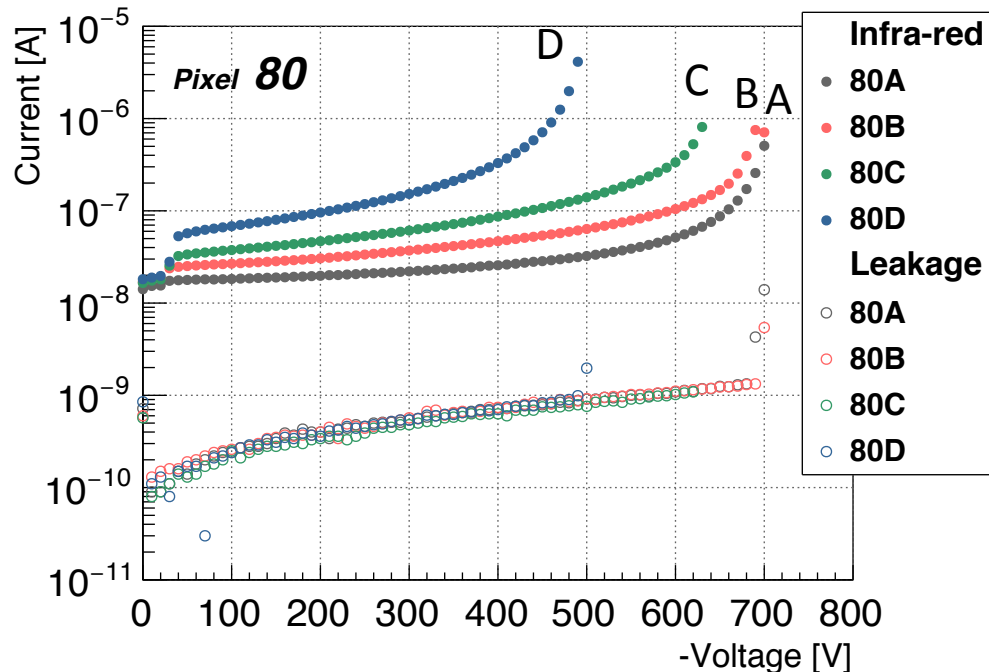




# p<sup>+</sup> density Dependence – Non irradi.



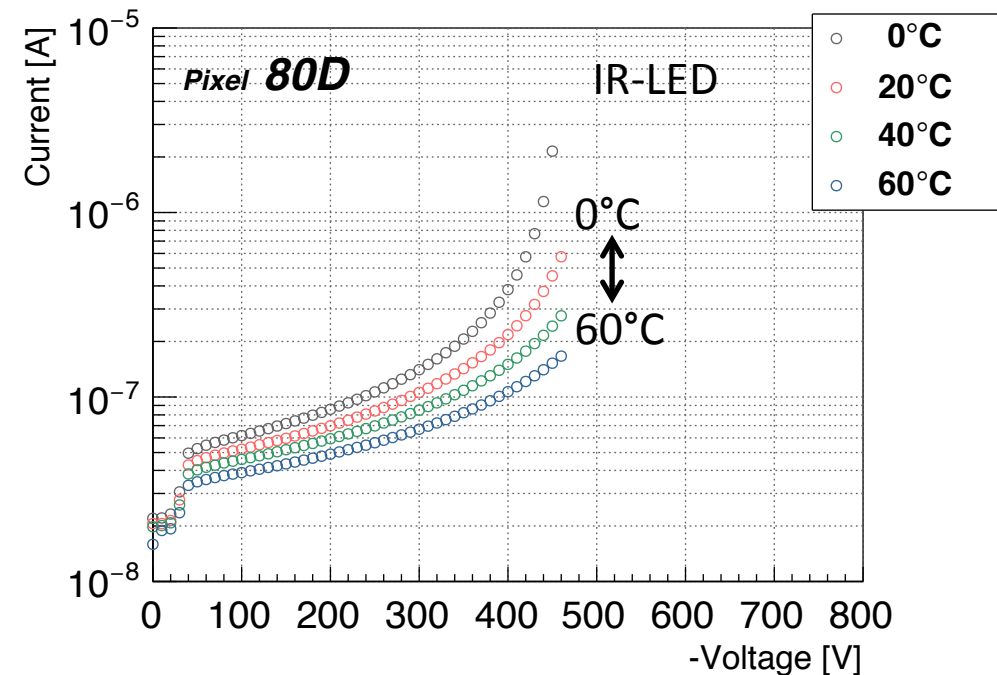
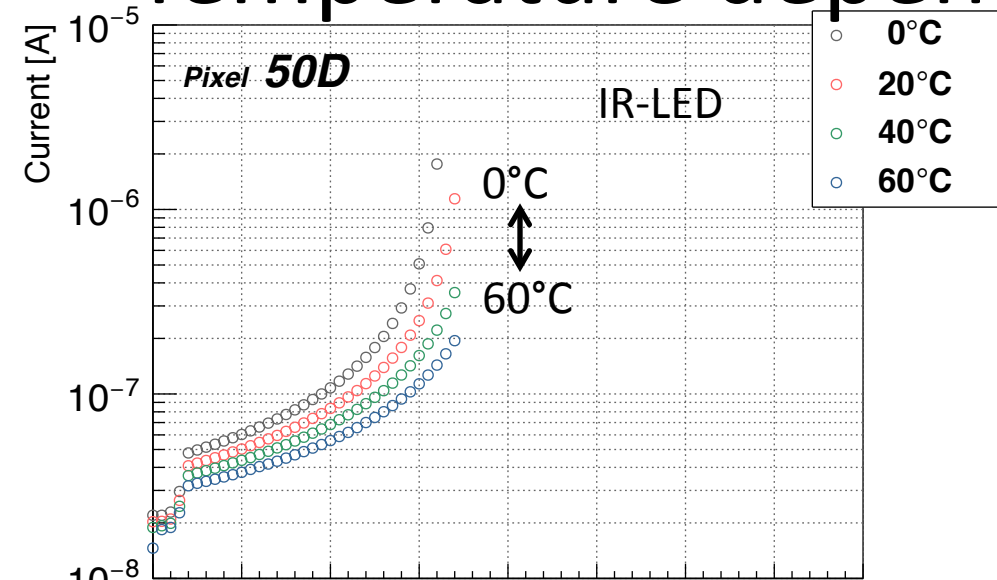
Sample Name	Voltage[V]	Gain
50C	470	31.9
50D	340	27.2
80A	680	9.4
80B	680	14.6
80C	620	13.8
80D	490	29.0



Definition of “Gain”:  $I(\text{Voltage})/I(100\text{V})$   
*LED power is controlled by the amplitude of the pulses (5kHz square pulses) sent to the LED.*

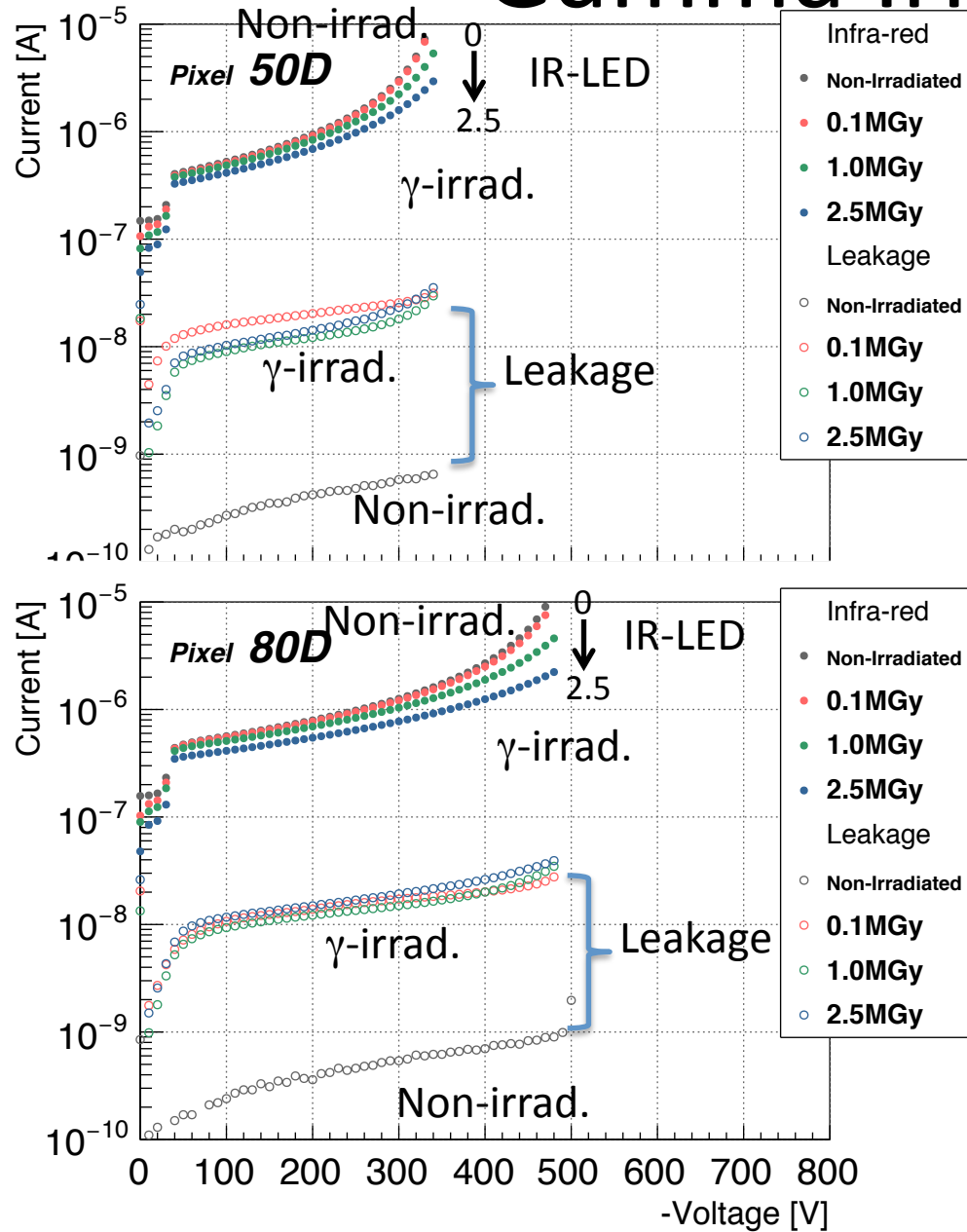
- Diode samples
- p<sup>+</sup> density
  - A, B: too weak(?)
  - (C) D: good

# Temperature dependence – Non irradi.



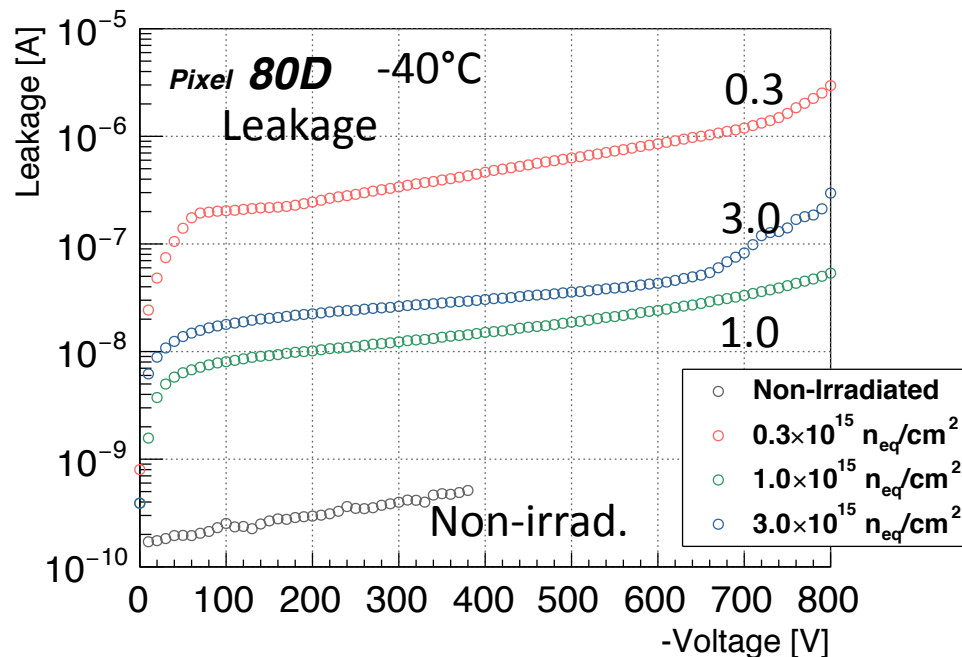
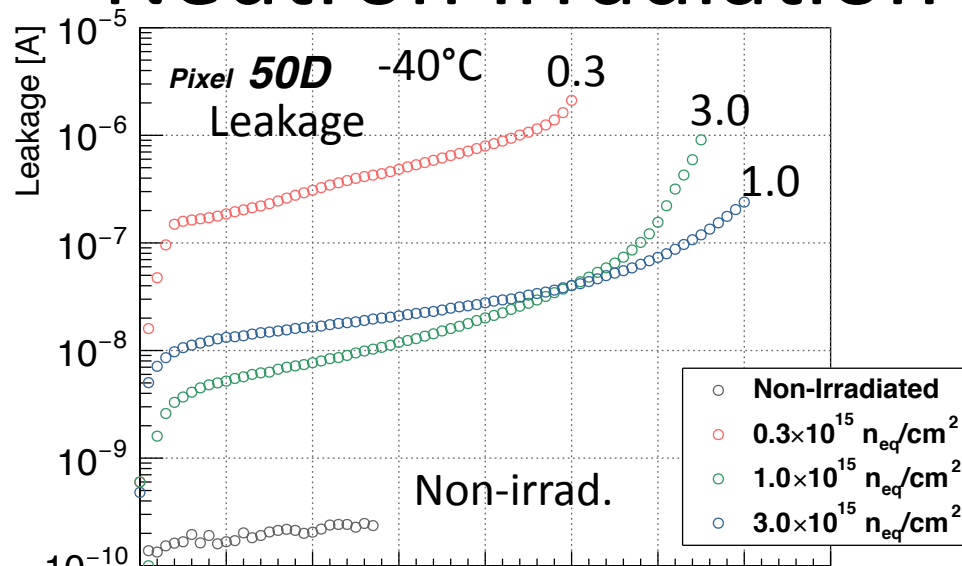
- Currents generated by LED  $\gg$  Leakage current
- No  $T^2 \exp(-E_g/2kT)$  dependence
- Lower, temperature
  - higher, gain
- Because
  - longer, mean free path
  - higher, accelerated energy
  - more, impact ionizations

# Gamma Irradiation



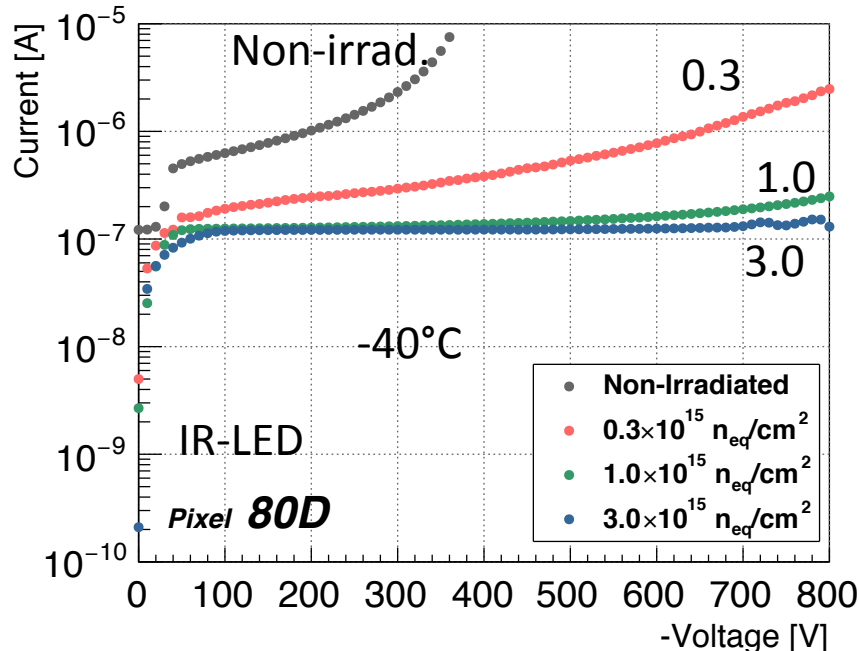
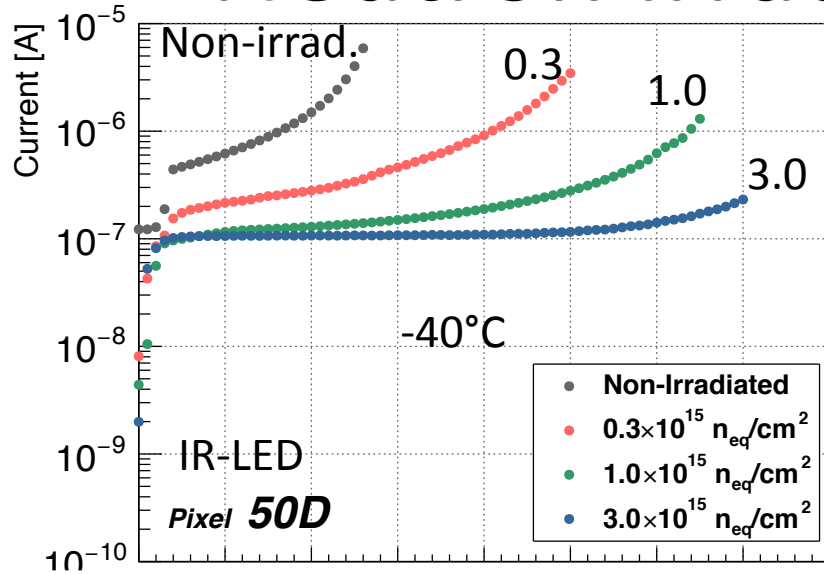
- 2016/11/25
  - at Takasaki (JAC)
  - 0.1/1.0/2.5 MGy
- Leakage currents:
  - 2 orders of mag.  $\uparrow$
  - (where?)
- Gain:
  - Decrease as dose  $\uparrow$
  - but not much.
- Surface effect is small.

# Neutron Irradiation – Leakage Current



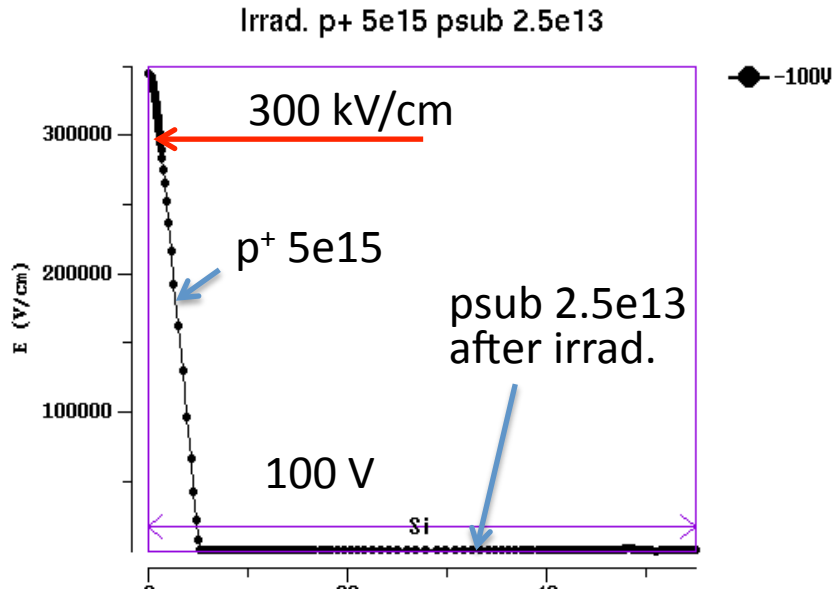
- 2016.12.15 @Ljubljana
- $0.3, 1.0, 3.0 \times 10^{15} \text{ neq/cm}^2$
- Annealed at  $60^\circ\text{C}$ -80 min.
- No  $\Delta I/V = \alpha \phi$  dependence
- Interplay (?) of
  - Bulk leakage current  $\uparrow$
  - Gain  $\downarrow$  (see next page)

# Neutron Irradiation – IR-LED

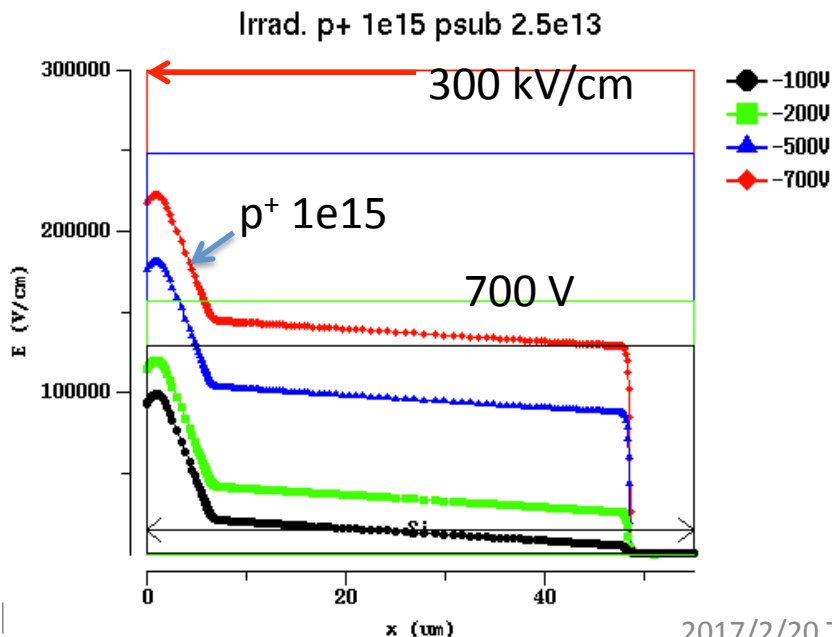


- 2016.12.15 @Ljubljana
  - $0.3, 1.0, 3.0 \times 10^{15} \text{ neq}/\text{cm}^2$
- Annealed at 60°C-80 min.
- Full depletion voltage:
  - $\sim 100 \text{ V}@80 \mu\text{m}$  at  $3 \times 10^{15}$
- Gain  $\downarrow$  as fluence  $\uparrow$

# Discussion



- Why the device loses the gain after neutron irradiation?



- If the p<sup>+</sup> density is  $\ll 5 \times 10^{15} \text{ cm}^{-3}$ , the peak E field won't reach the critical avalanche breakdown field of
  - $\sim 30 \text{ V}/\mu\text{m}$  (i.e. 300 kV/cm)

# Summary

- Variations of pixel structures of  $50 \times 50$  or  $25 \times 100 \mu\text{m}^2$  were evaluated against efficiency loss due to the structures.
- All structures work ( $\geq 95\%$ , e.g.) after irradiation of protons to  $3 \times 10^{15}$  neq/cm<sup>2</sup> expected at the HL-LHC.
- The elements of the structures where the loss occurs have been identified and can be improved in the next prototyping, including the threshold of ASIC (with RD53A chip).
- Amplification of charges (“Gain”) were evaluated in the newly fabricated LGAD devices (diodes, strips).
- Only a small decrease of Gain was observed with the gamma irradiation, i.e., the surface effect is small.
- A large decrease of Gain was observed with the neutron irradiations. Understanding the physics behind is the next step.

# Contributors & Acknowledgement

- ATLAS-Japan Silicon Collaboration
  - KEK, Uni. Tsukuba, Tokyo Tech., Kyoto Edu., Osaka Uni., Kyushu Uni.
- S. Kamada, Y. Abo, K. Yamamura, H. Yamamoto (HPK)
- ATLAS Planar Pixel Sensor (PPS) Collaboration
  - AS CR, Prague, LAL Orsay, LPNHE/Paris VI, Uni. Bonn, HU Berlin, DESY, TU Dortmund, Uni. Göttingen, MPP and HLL Munich, Uni. Udine-INFN, KEK, Tokyo Inst. Tech., IFAE-CNM, Uni. Geneva, Uni. Liverpool, UC Berkeley, UNM-Albuquerque, UC Santa Cruz
- M. Ito et al., CYRIC, Tohoku University for proton irradiation
- Takasaki Advanced Radiation Research Institute, Japan Atomic Energy Agency for gamma irradiation
- F. Cindro, I. Mandic, M. Mikuz, et al., Josef Stefan Institute and TRIGA reactor team at Ljubljana for the neutron irradiation, through AIDA GA no. 654168.



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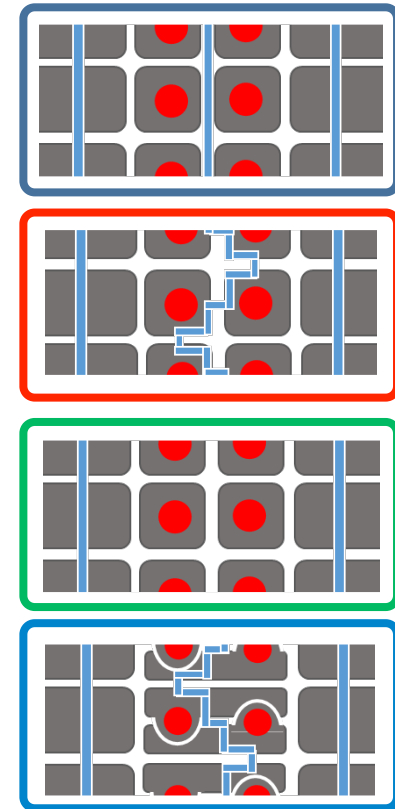
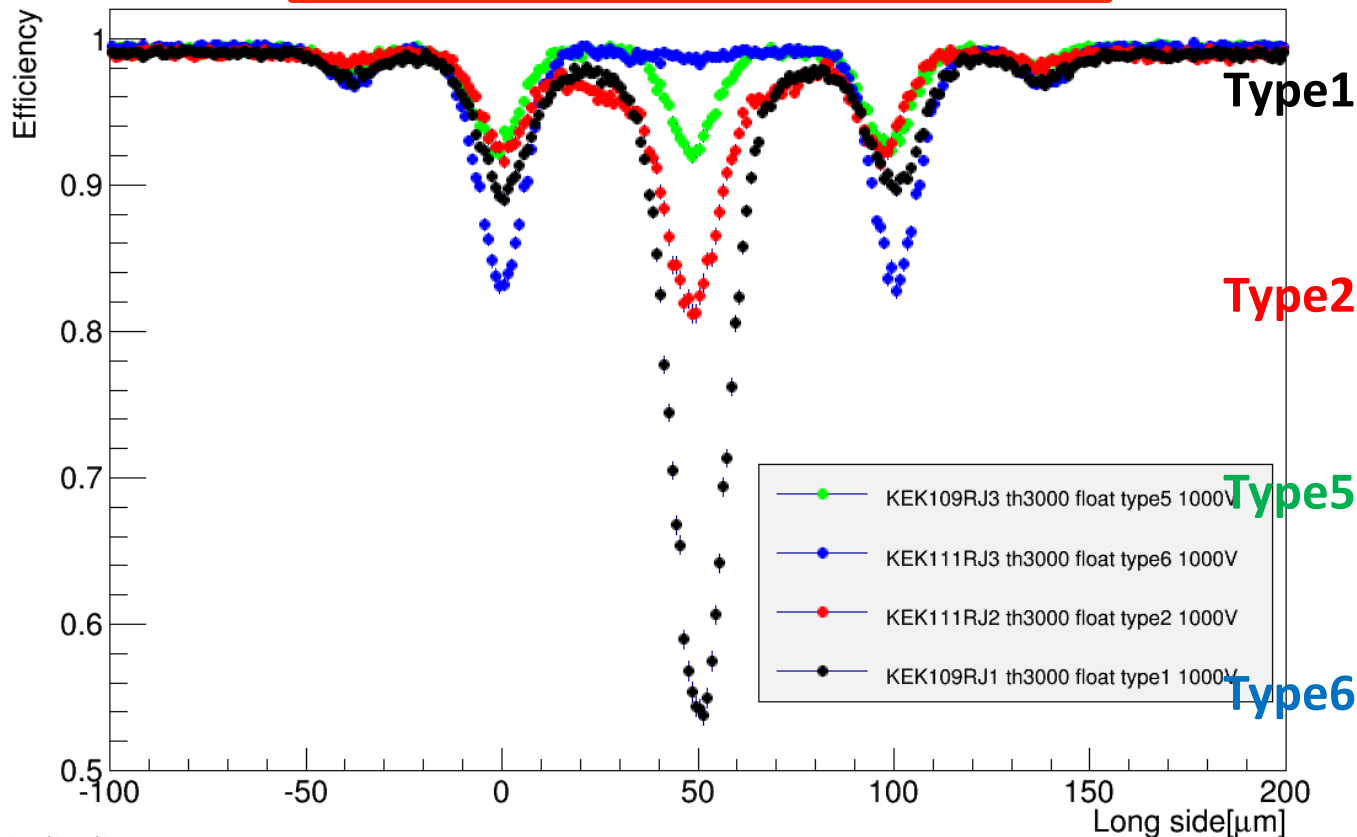


# Backup

# Efficiency Map Projection

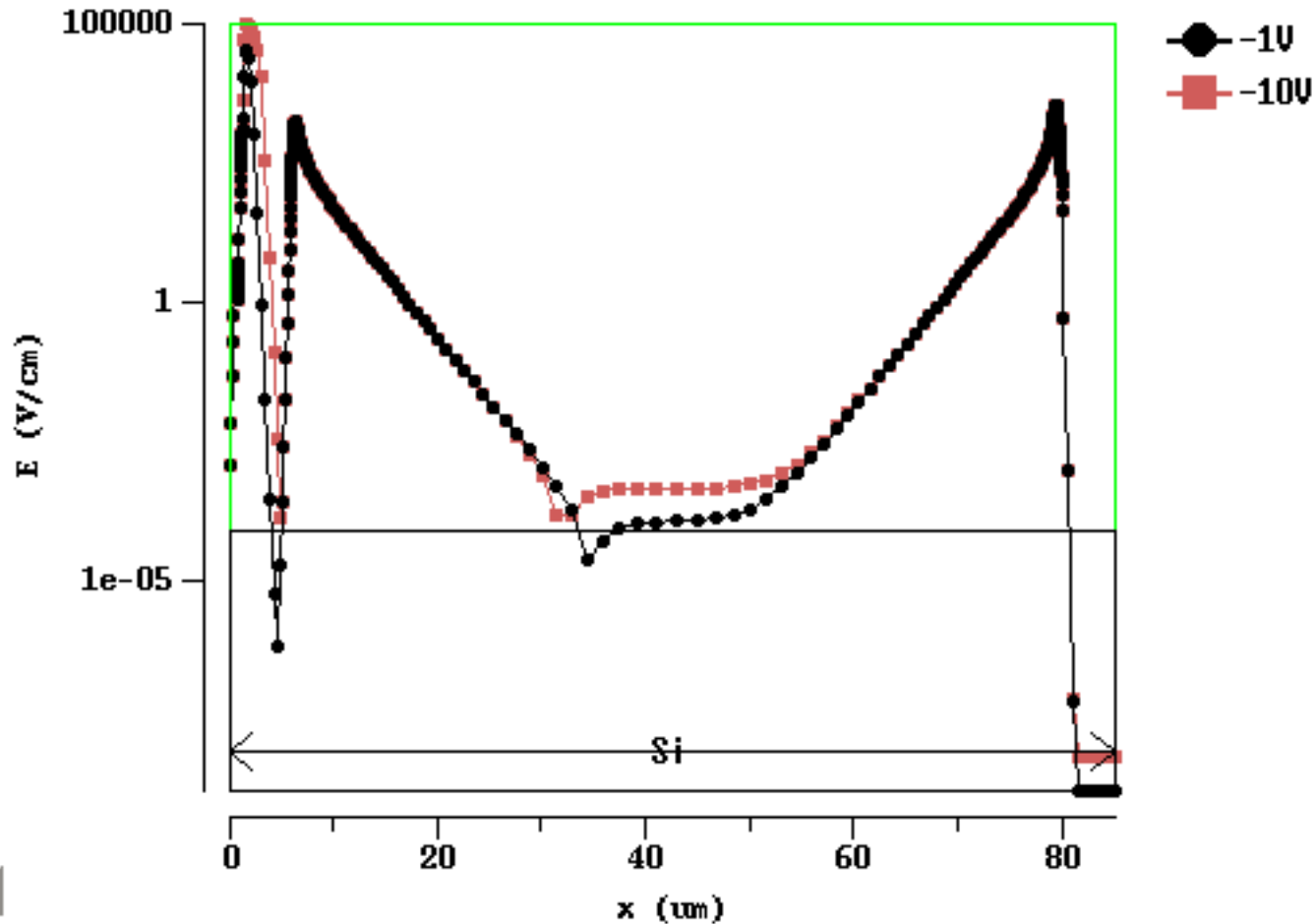
- The loss at the boundary of pixels of 50  $\mu\text{m}$  and 450  $\mu\text{m}$  is the same for all devices
  - Basically the same structure (the four corner)
- Loss between 50  $\mu\text{m}$  pixels: Type1 > Type2 > Type5
  - Geometry of the bias rail

Proton Irrad  $3 \times 10^{15}$  1MeV  $n_{\text{eq}}/\text{cm}^2$



# Depletion with Low Bias Voltages

Non-irrad. p+ 5e15 psub 4.7e12



- psub is also depleted, partially...